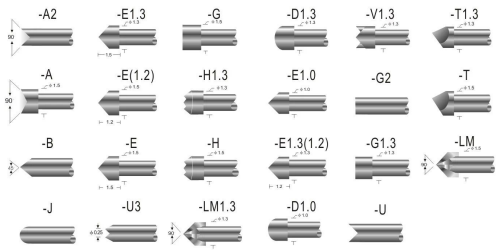
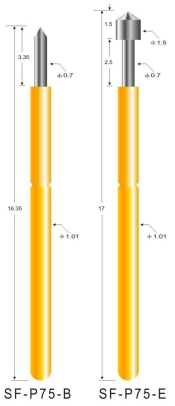
PCB 테스트 스프링 장착 접점 프로브

제품 정보

상표	SFENG
품목 번호	PCB 테스트 스프링 장착 접점 프로브
시리즈	SF-PA75, SF-PA11 과 SF-PA111
플런저	Cu, 금 / 니켈 도금
몸	황동, 금도금
봄	스테인레스
스프링 력	120g, 150g, 과 120g
씨급한 비율엔	3A

SF-P75



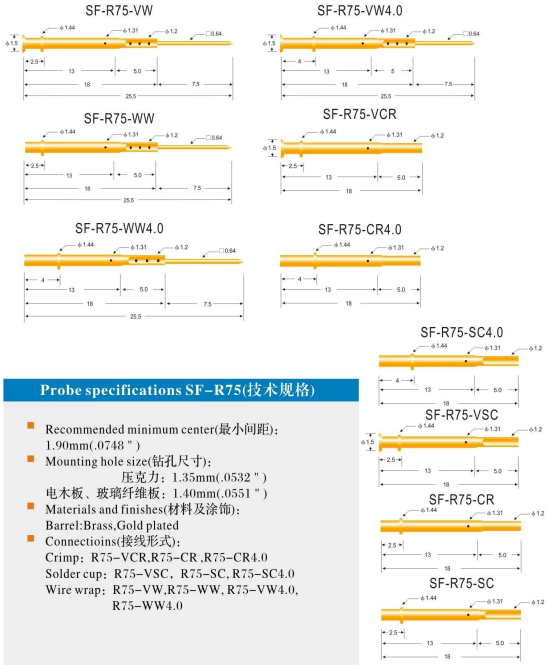


Probe specifications SF-P75(技术规格)

- Recommended minimum center(最小间距):
  1.90mm(.0748 ")
- Mounting hole size(钻孔尺寸):
  压克力：1.35mm(.0532 ")
  电木板、玻璃纤维板：1.40mm(.0551 ")
- Full travel(行程)：3.35(.1319 ")/2.50(.0984 ")
- Spring force(弹簧压力)：120g
- Materials and finishes(材料及涂饰):
  Plunger:Be Cu,Rh plated；SK4,Rh plated
  Barrel:Phosphor bronze,Gold plated
  Spring:Stainless steel
- Current ration(额定电流)：3A(安培)
- Contact resistance(接触电阻)：50mΩ(毫欧姆)

Noted：Specifications subject to change without notice注：规格变动不另行通知

SF-R75



Probe specifications SF-R75(技术规格)

- Recommended minimum center(最小间距):
  1.90mm(.0748 ")
- Mounting hole size(钻孔尺寸):
  压克力：1.35mm(.0532 ")
  电木板、玻璃纤维板：1.40mm(.0551 ")
- Materials and finishes(材料及涂饰):
  Barrel:Brass,Gold plated
- Connectioins(接线形式):
  Crimp：R75-VCR,R75-CR ,R75-CR4.0
  Solder cup：R75-VSC、R75-SC, R75-SC4.0
  Wire wrap：R75-VW,R75-WW, R75-VW4.0,
  R75-WW4.0

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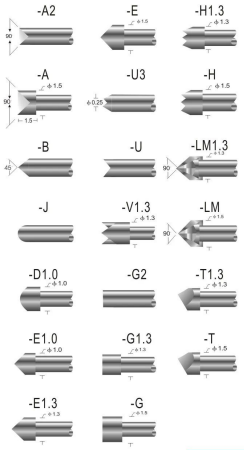
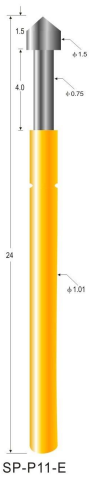
SF-P11



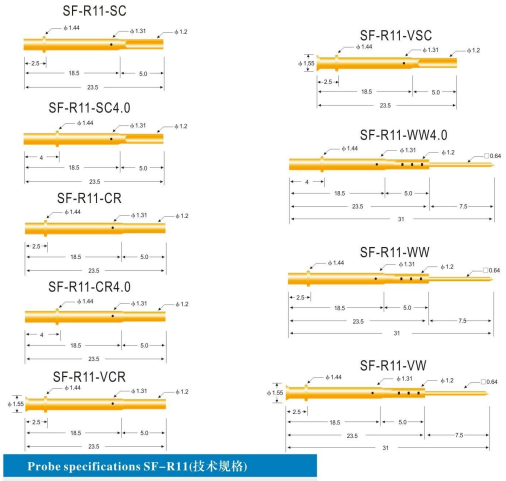


Probe specifications SF-P11(技术规格)

- Recommended minimum center(最小间距):
  1.90mm(.0748 ")
- Mounting hole size(钻孔尺寸):
  压克力：1.35mm(.0532 ")
  电木板、玻璃纤维板：1.40mm(.0551 ")
- Full travel(行程)：4.0(.1575 ")
- Spring force(弹簧压力)：150g
- Materials and finishes(材料及涂饰):
  Plunger:Be Cu,Rh plated
  Barrel:Brass,Gold plated
  Spring:Stainless steel
- Current ration(额定电流)：3A(安培)
- Contact resistance(接触电阻)：50mΩ(毫欧姆)

Noted：Specifications subject to change without notice注：规格变动不另行通知

SF-R11



Probe specifications SF-R11(技术规格)

- Recommended minimum center(最小间距):
  1.90mm(.0748 ")
- Mounting hole size(钻孔尺寸):
  压克力：1.35mm(.0532 ")
  电木板、玻璃纤维板：1.40mm(.0551 ")
- Materials and finishes(材料及涂饰):
  Barrel:Brass,Gold plated
- Connectioins(接线形式):
  Crimp：R11-VCR,R11-CR,R11-CR4.0
  Solder cup：R11-VSC、R11-SC,R11-SC4.0
  Wire wrap：R11-VW,R11-WW,R11-WW4.0

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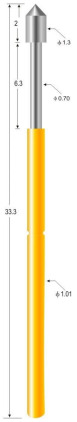
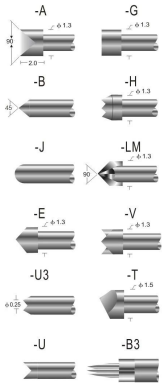
SF-P111



SF-P111-E



Probe specifications SF-P111(技术规格)

- Recommended minimum center(最小间距):
  1.90mm(.0748 ")
- Mounting hole size(钻孔尺寸):
  压克力：1.35mm(.0532 ")
  电木板、玻璃纤维板：1.40mm(.0551 ")
- Full travel(行程)：6.3(.2481 ")
- Spring force(弹簧压力)：120g
- Materials and finishes(材料及涂饰):
  Plunger:Be Cu,Rh plated
  Barrel:Brass,Gold plated
  Spring:Stainless steel
- Current ration(额定电流)：3A(安培)
- Contact resistance(接触电阻)：50mΩ(毫欧姆)

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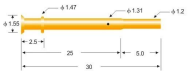
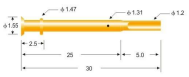
SF-R111

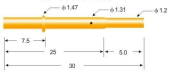
SF-R111-VCR2.5



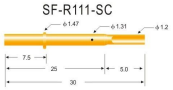
SF-R111-VSC2.5



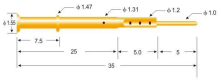
SF-R111-CR



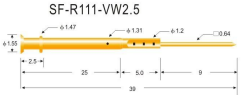
SF-R111-SC



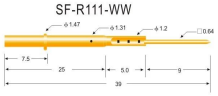
SF-R111-VW(T)



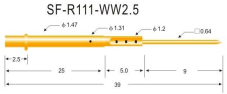
SF-R111-VW2.5



SF-R111-WW



SF-R111-WW2.5



Probe specifications SF-R111(技术规格)

- Recommended minimum center(最小间距):
  1.90mm(.0748 ")
- Mounting hole size(钻孔尺寸):
  压克力：1.35mm(.0532 ")
  电木板、玻璃纤维板：1.40mm(.0551 ")
- Materials and finishes(材料及涂饰):
  Barrel:Brass,Gold plated
- Connectioins(接线形式):
  Crimp：R111-VCR2.5,R111-CR
  Solder cup：R111-VSC2.5，R111-SC
  Wire wrap：R111-VW2.5,R111-WW2.5,R111-WW
  Terminal：R111-VW(T)

Noted：Specifications subject to change without notice(注：规格变动不另行通知

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1. Raw material warehouse

2. Lathe workshop

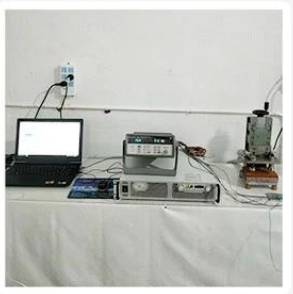
3. Assemble workshop

4. Quality inspection

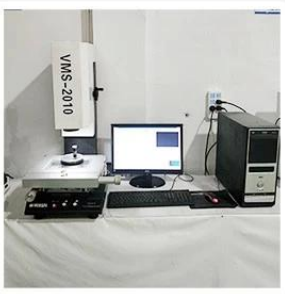
5. Finished products

6. Packing

□□□ □□



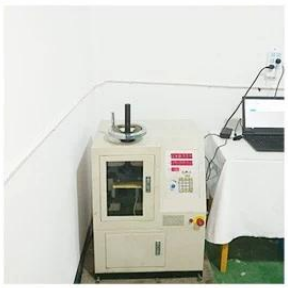
1. Agilent current testing



2. Quadratic element

3.Load Curve Meter

4.Bond Test



5.Life Fatigue Test

6.Microscope

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Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.